

**MI BPM Project**  
**MI BPM TB Control Module Status Report May 9<sup>th</sup>, 2006**

Significant changes are highlighted.

**MI BPM TB Control Module Production**

**Hardware status:**

- ) Work in progress on the “Functional Requirements Specification”.
- ) Conceptual design of the production version of the Control Module completed.
- ) Electrical Schematic completed.
- ) Parts ordering completed.
- ) Printed Circuit Board Layout completed.
- ) Print Circuit Boards received.
- ) One Module assembled and tested.
- ) Other modules Assembly/testing in progress.

Thanks to Tim Kasza for provide some supplemental manpower  
(Stew Bledsoe and Rick Mahlum) for the Control Module assembly task.

- ) Front Panel design completed.
- ) Front Panel Purchase Order placed, manufacturing in progress.

**Firmware status:**

- ) Coding work in progress.

**MI BPM TB**

**Firmware status:**

- ) Conceptual work in progress together with Control Module (production version) design.

**MI BPM TB Control Module Prototype**

**Hardware status:**

- ) No activities.

**Firmware status (Avnet Xilinx card FPGA):**

- ) No activities.

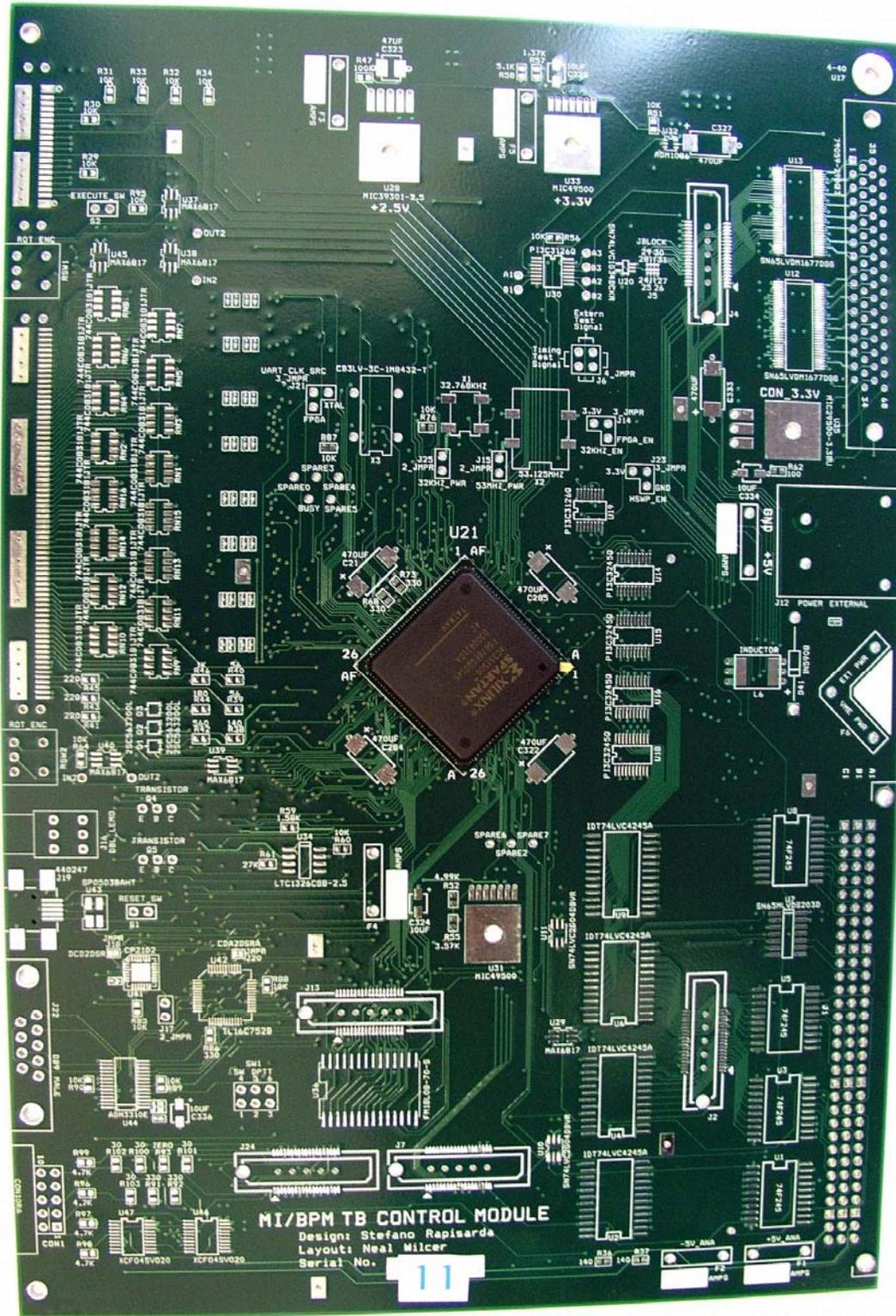
Document related to the Control Module are available on the web page:

[http://www-ese.fnal.gov/MI\\_BPM\\_TB\\_CTL/](http://www-ese.fnal.gov/MI_BPM_TB_CTL/)

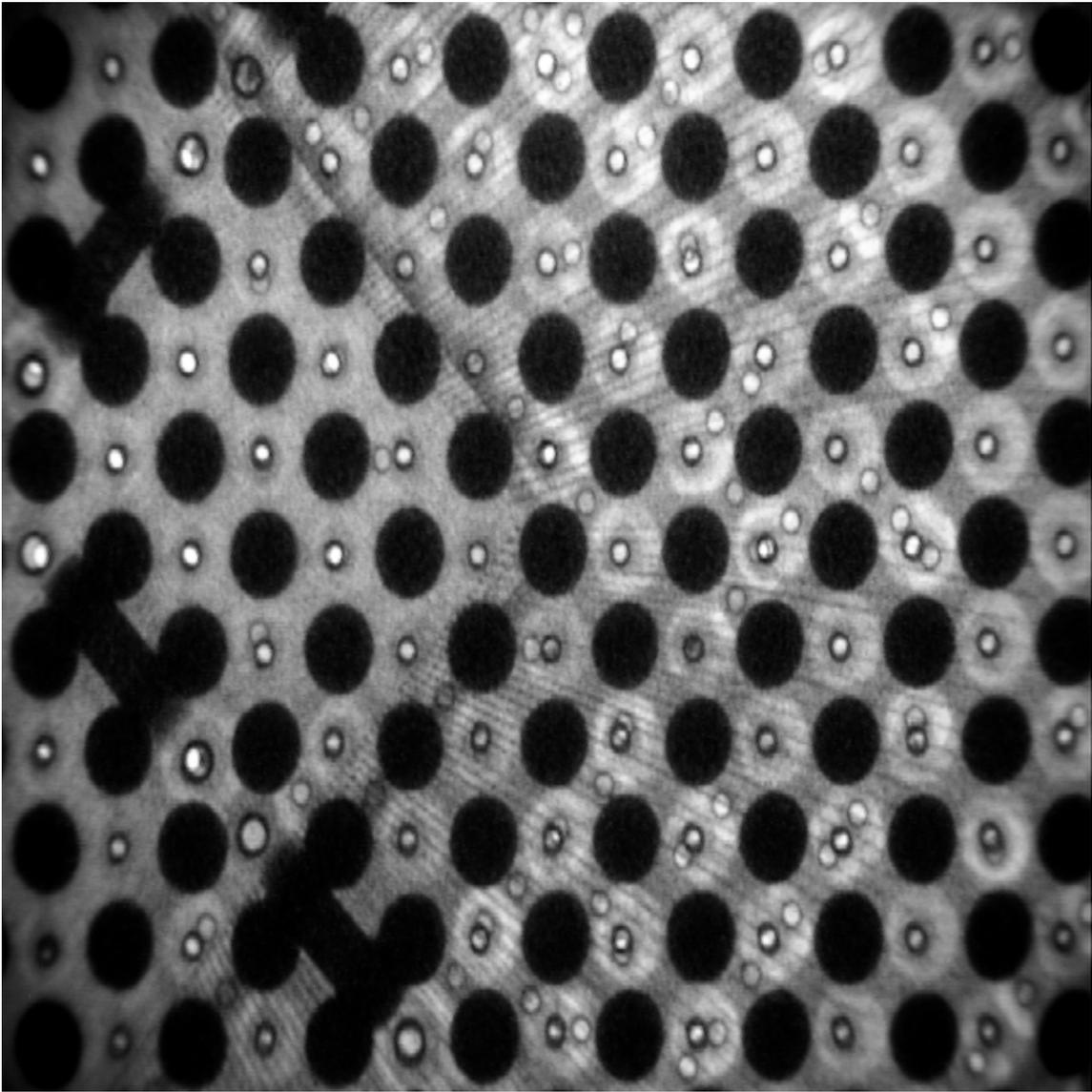
**MI BPM Project**  
**MI BPM TB Control Module Time Schedule**  
 As on February 28<sup>th</sup>, 2006, last modified on May 9<sup>th</sup>, 2006

New changes in schedule are **highlighted**. Previous changes in schedule are **in blue**.

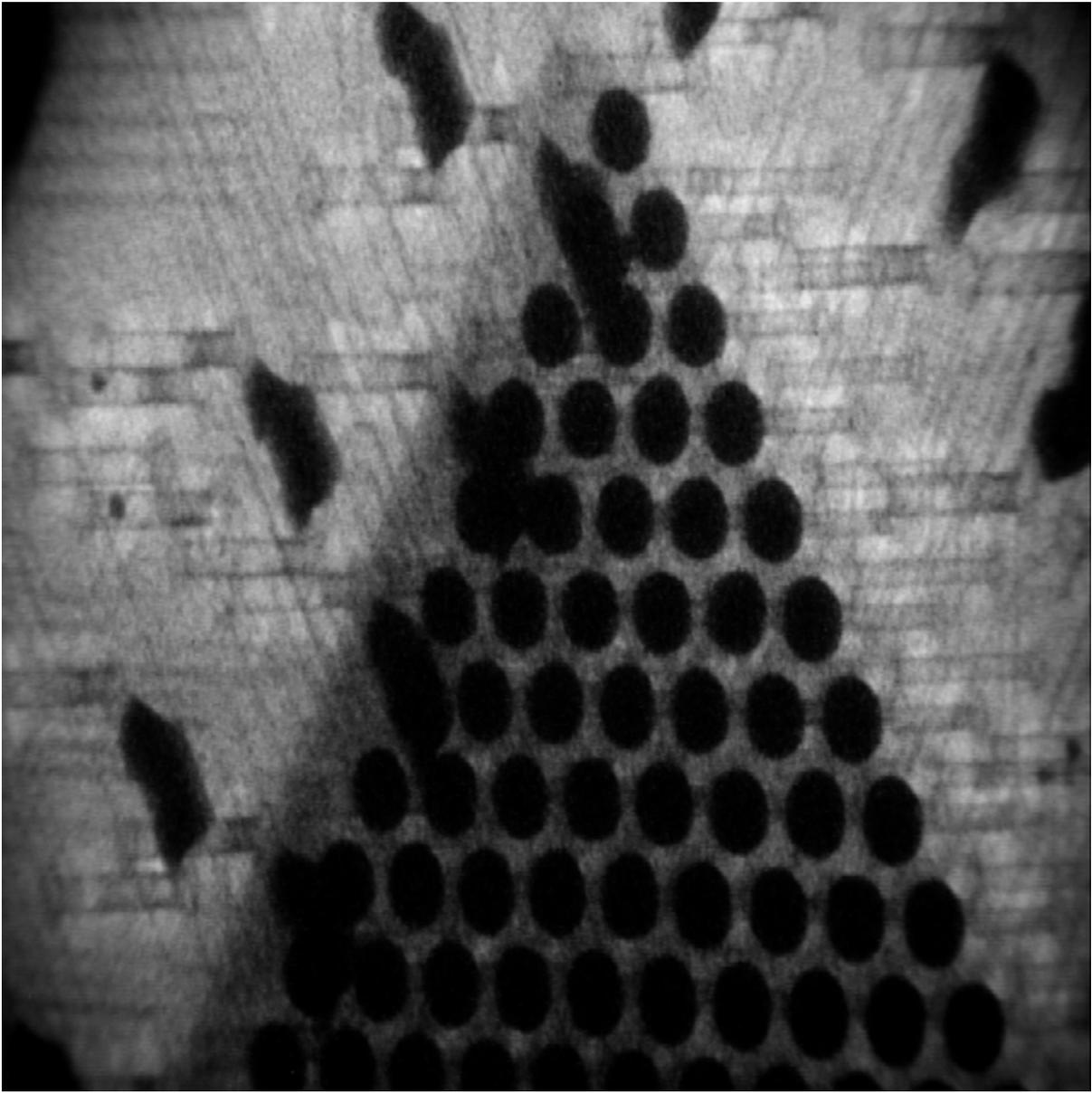
Week beginning on	Task 1	Task 2	Task 3	Task 4	Goals and decisions
February 27 <sup>th</sup>	Design				
March 6 <sup>th</sup>	Design	Schematic			Finalize design
March 13 <sup>th</sup>	Firmware	Schematic			
March 20 <sup>th</sup>	Firmware	Schematic <b>review</b>			Minor design changes
March 27 <sup>th</sup>	Firmware	<b>Schematic</b> PCB layout		Parts ordering	
April 3 <sup>rd</sup>	Firmware	<b>Schematic review</b> PCB layout		<b>Parts ordering</b> <del>Parts arrive</del>	
April 10 <sup>th</sup>	Firmware	PCB layout	<del>PCB quotes</del>	Parts arrive	
April 17 <sup>th</sup>	Firmware	PCB layout <del>PCB</del> manufacturing	PCB quotes <del>Front panel</del> design	Parts arrive	<del>Finalize preliminary version of firmware.</del>
April 24 <sup>th</sup>	<b>Firmware</b>	<b>PCB</b> <b>Manufacturing</b> Module assembly	<del>Front panel</del> manufacturing <b>Front panel</b> design		Finalize preliminary version of firmware. <del>1<sup>st</sup> Module assembled and tested</del>
May 1 <sup>st</sup>		Module assembly	Front panel manufacturing		<b>1<sup>st</sup> Module assembled and tested</b> May 1 <sup>st</sup> : Does module meets system requirements?
May 8 <sup>th</sup>		<b>Module assembly/</b> Module testing	Front panel manufacturing		
May 15 <sup>th</sup>		<b>Module testing</b>			May 15 <sup>th</sup> : All Modules assembled and tested
May 22 <sup>nd</sup>					
May 29 <sup>th</sup>					



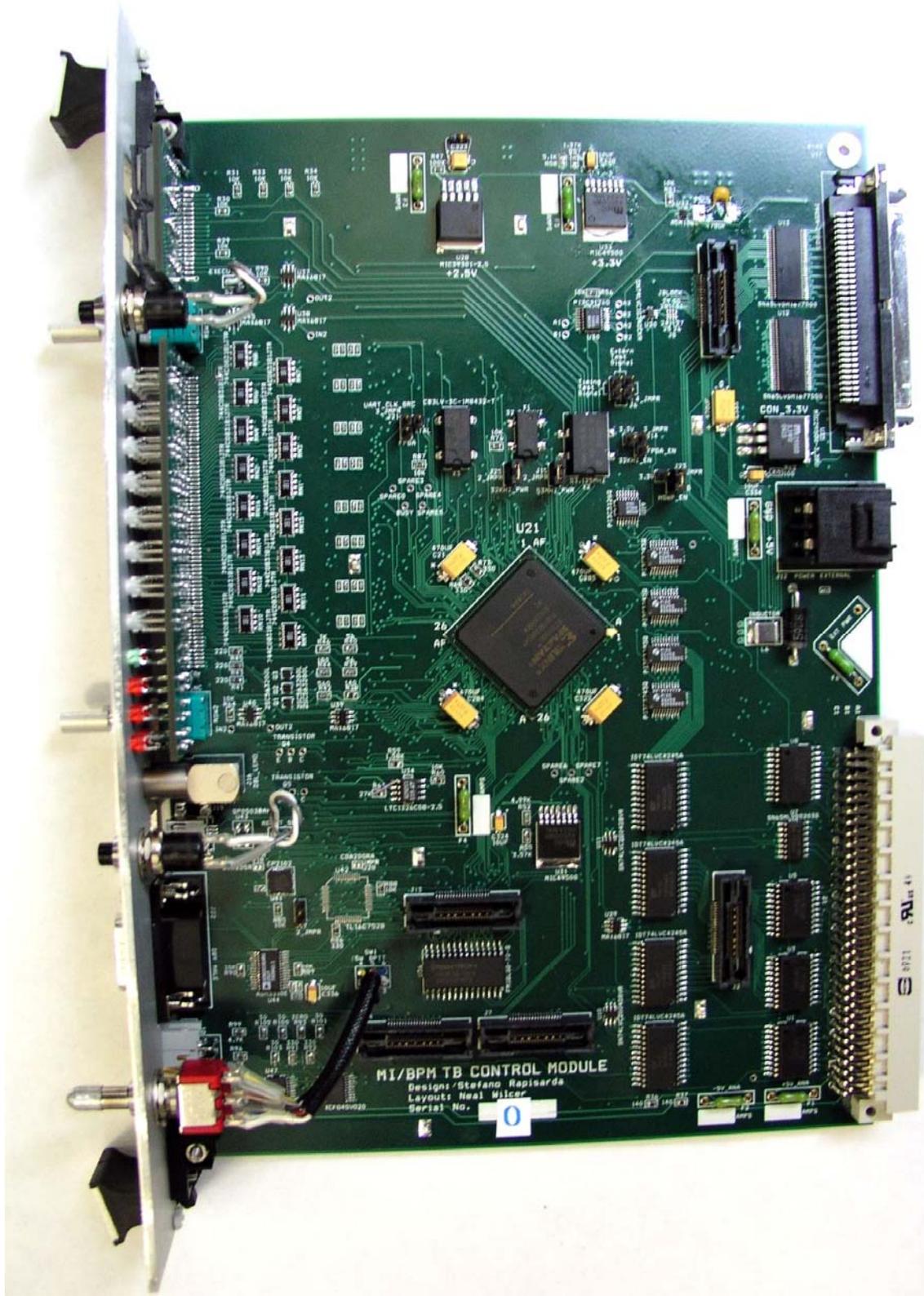
Control Module with FPGA only. FPGA Assembly done by Rick Mahlum.



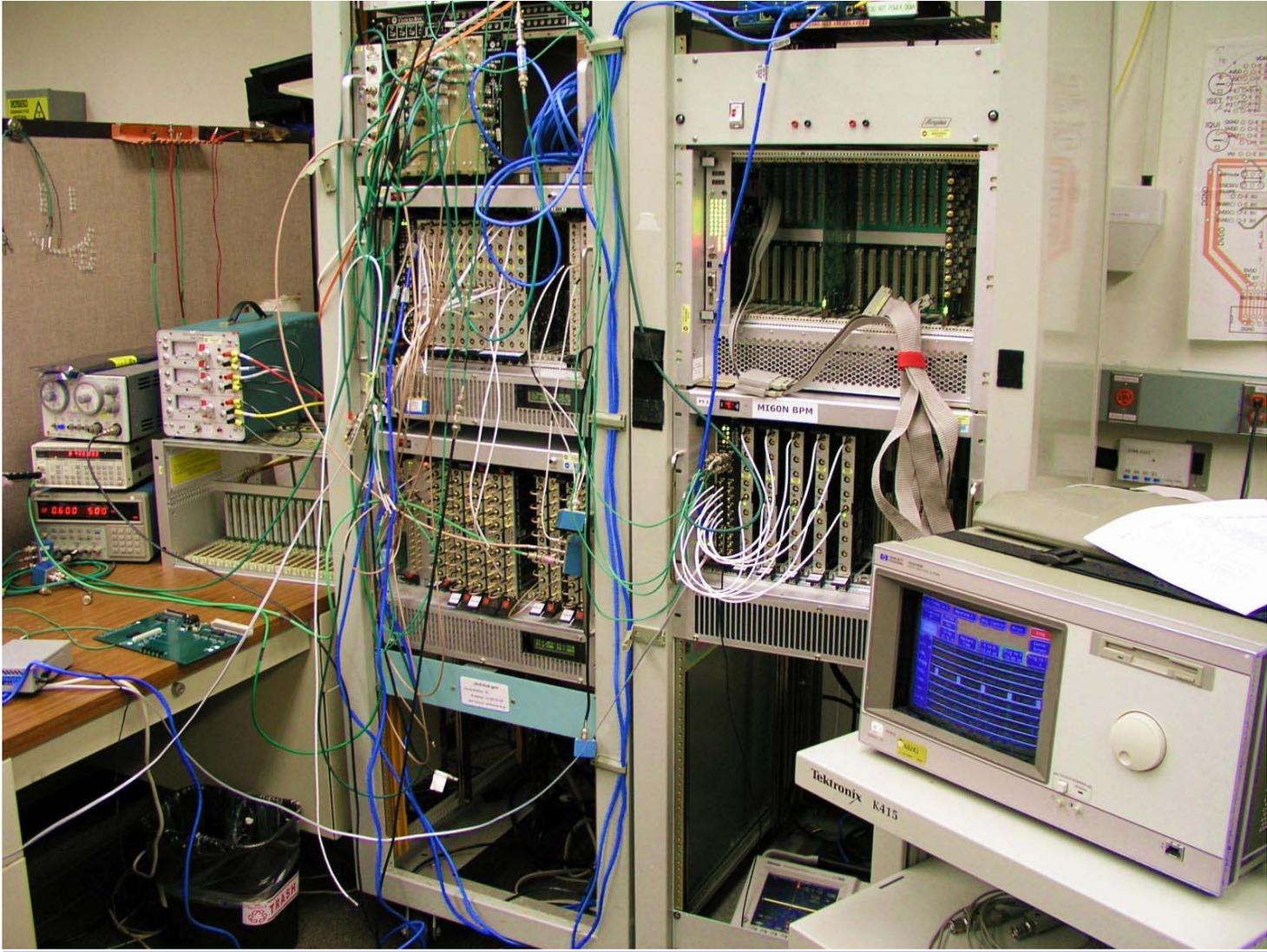
X-Ray of FPGA (center), photo by Jim Franzen.



X-Ray of FPGA (corner), photo by Jim Franzen.



Control Module fully assembled.  
Assembly done by Neal Wilcer, Stew Bledsoe and Rick Mahlum.



FCC Test Area